2.1 Class-D Digital Input Closed Loop Audio Amplifier System with Signal Processing

TIDA-00404 Test Data

TAS5756 THD+N Vs. Frequency 1 Watt into 8 ohms
Channel A Blue Channel B Green

TAS5760 Subwoofer Out THD+N Vs. Frequency 1 Watt into 8 ohms
TAS5756 Bandwidth 1 Watt into 8 ohms
Channel A Blue Channel B Green

TAS5760 Subwoofer Out Bandwidth 1 Watt into 8 ohms
TAS5756 FFT 1KHz Fundamental at 1 Watt into 8 ohms
Channel A Blue Channel B Green

TAS5760 Subwoofer Out FFT 1KHz Fundamental at 1 Watt into 8 ohms
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